

APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	PROCESS OF FABRICATING CONDUCTIVE COLUMN AND CIRCUIT BOARD WITH CONDUCTIVE COLUMN
Application Type :	regular, utility
Attorney Docket Number :	14098-US-PA
Correspondence address:	
Customer Number:	31561
	
Priority Data:	
Doc.No: 93122358; Country -TW ; Date: 2004-07-27 us-priority-claimed	
Inventor Information:	
<u>Inventor 1:</u>	
Applicant Authority Type:	Inventor
Citizenship:	TW
Name prefix:	Mr.
Given Name:	David C. H.
Family Name:	Cheng
Residence:	
City of Residence:	Taoyuan Hsien
Country of Residence:	TW
Address-1 of Mailing Address:	5FL.-2, No. 110, Hsi-Kang Rd., Lu-Chu
Address-2 of Mailing Address:	
City of Mailing Address:	Taoyuan Hsien
State of Mailing Address:	
Postal Code of Mailing Address:	
Country of Mailing Address:	TW
Phone:	
Fax:	
E-mail:	
Attorney Information:	
practitioner(s) at Customer Number:	

31561



as my attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.